

Sheet 1 of 2 sheet(s)

U.S. Department of Commerce, Patent and Trademark Office (PTO Form 1449 modified)		Docket No. APPM/5538	Serial No. 09/755,717
LIST OF PATENTS AND PUBLICATIONS CITED BY APPLICANT COPY		Applicant Sun, et al.	Confirmation No.:
(Use several sheets if necessary)		Filing Date January 5, 2001	Group Unknown
Examiner Unknown			

U.S. Patent Documents

*Examiner Initial		Document Number	Issue Date	Applicant(s) Name	Class	Subclass	Filing Date If Appropriate
LV	A1	6,117,783	09-12-2000	Small, et al.	438	693	07-21-1997
	A2	6,083,840	07-04-2000	Mravlc, et al.	438	693	11-25-1998
	A3	6,074,949	06-13-2000	Schonauer, et al.	438	692	11-25-1998
	A4	6,001,730	12-14-1999	Farkas, et al.	438	627	10-20-1997
	A5	5,985,755	11-16-1999	Bajaj, et al.	438	645	03-24-1997
	A6	5,985,748	11-16-1999	Walts, et al.	438	622	12-01-1997
	A7	5,893,796	04-13-1999	Birang, et al.	451	526	08-16-1996
	A8	5,842,910	12-01-1998	Krywanczyk, et al.	451	41	03-10-1997
	A9	5,820,450	10-13-1998	Calhoun	451	530	05-19-1997
	A10	5,770,095	06-23-1998	Sasaki, et al.	216	38	07-11-1995
	A11	5,693,663	12-02-1997	Teong	437	190	07-15-1996
	A12	5,692,950	12-02-1997	Rutherford, et al.	451	552	08-08-1996
LV	A13	5,676,587	10-14-1997	Landers, et al.	451	57	12-06-1995

Foreign Patent Documents

*Examiner Initial		Document Number	Date	Country	Class	Subclass	Translation	
							YES	NO
							<input type="checkbox"/>	<input type="checkbox"/>

OTHER ART

*Examiner Initial		Including Author, Title, Date, Pertinent Pages, Etc.
LV	C1	"Aluminum Based Multilevel Metallizations", from Handbook of Multilevel Metallization for Integrated Circuits, Wilson & Tracy, Eds. (1993), pp. 139-140
LV	C2	USSN 09/401,643, filed September 22, 1999
LV	C3	USSN 09/569,988, filed May 11, 2000

Examiner	LAN VINH	Date Considered	10/6/05
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.			

